

Essentials of MOSFETs

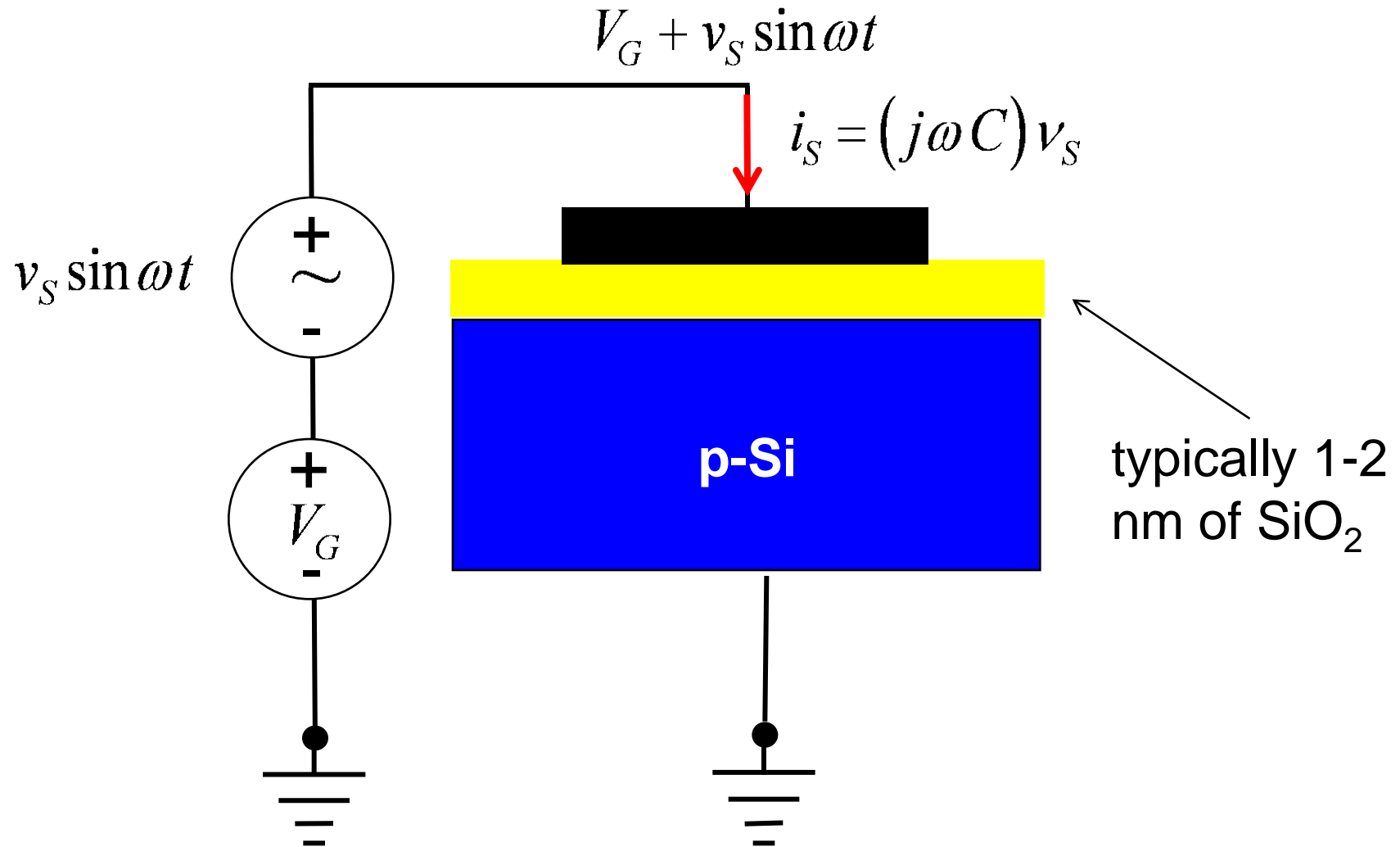
Unit 3: MOS Electrostatics

Lecture 3.5: MOS CV

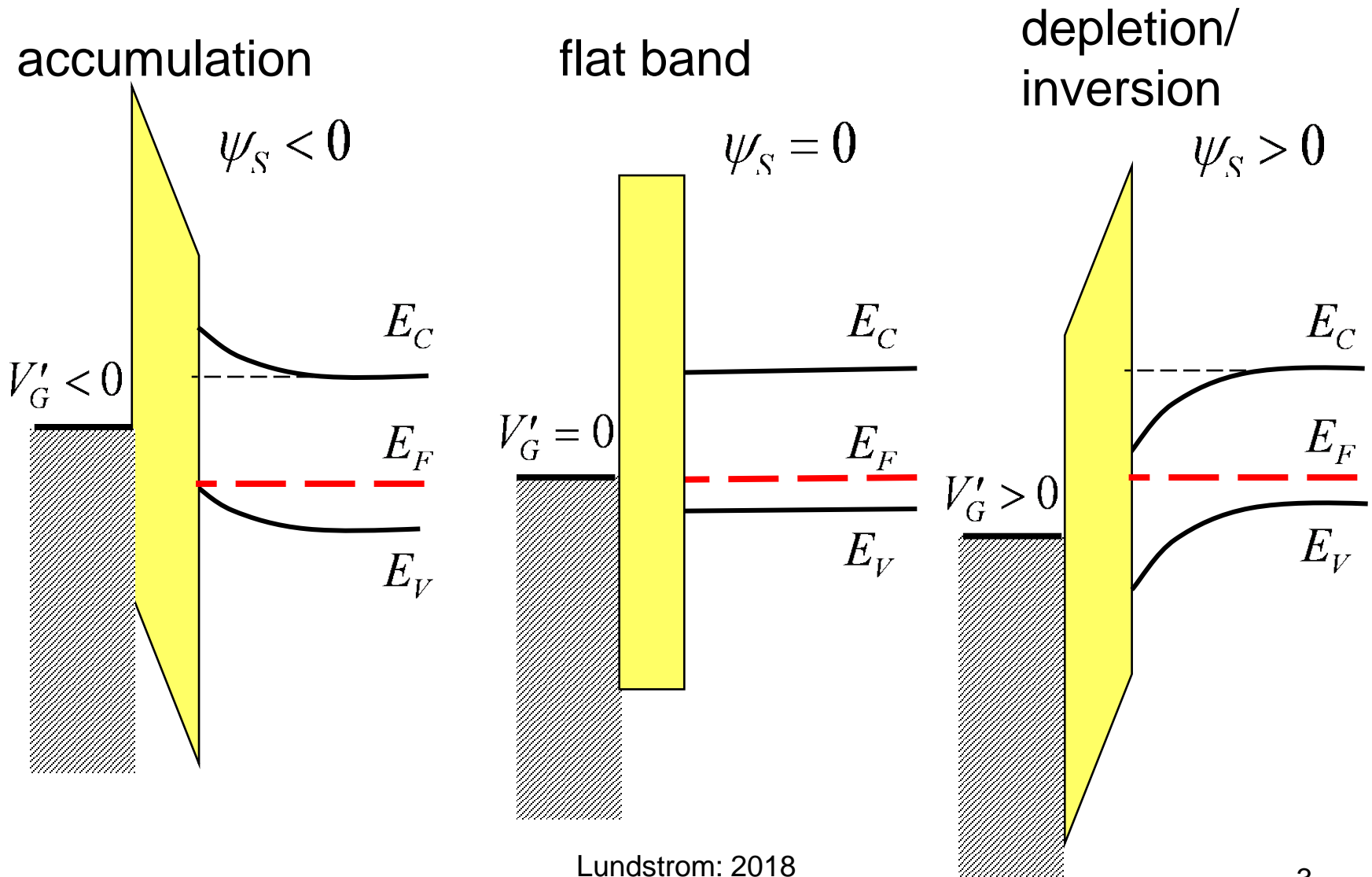
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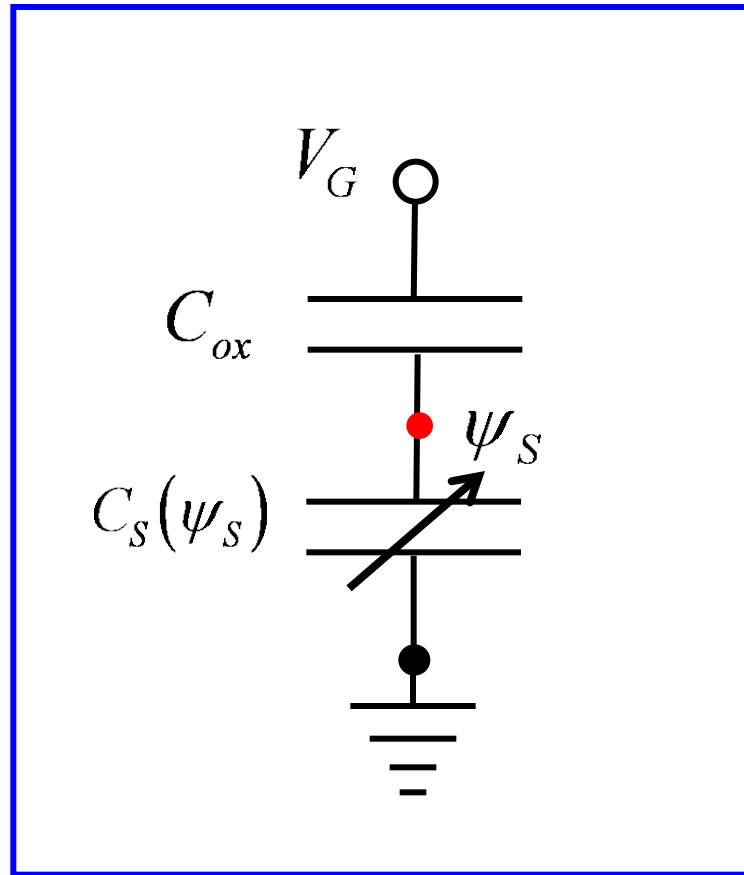
MOS capacitor



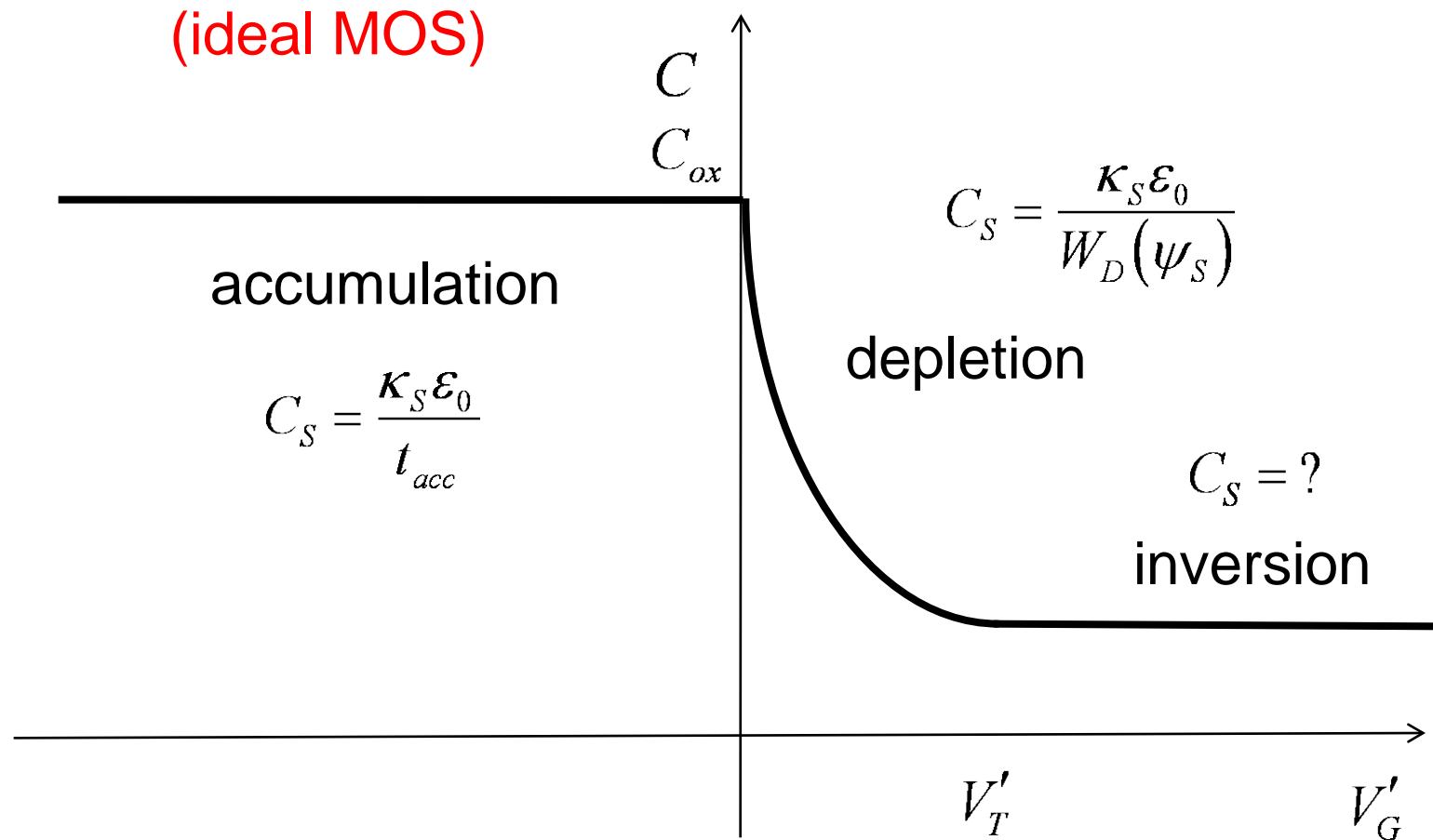
Effect of DC bias



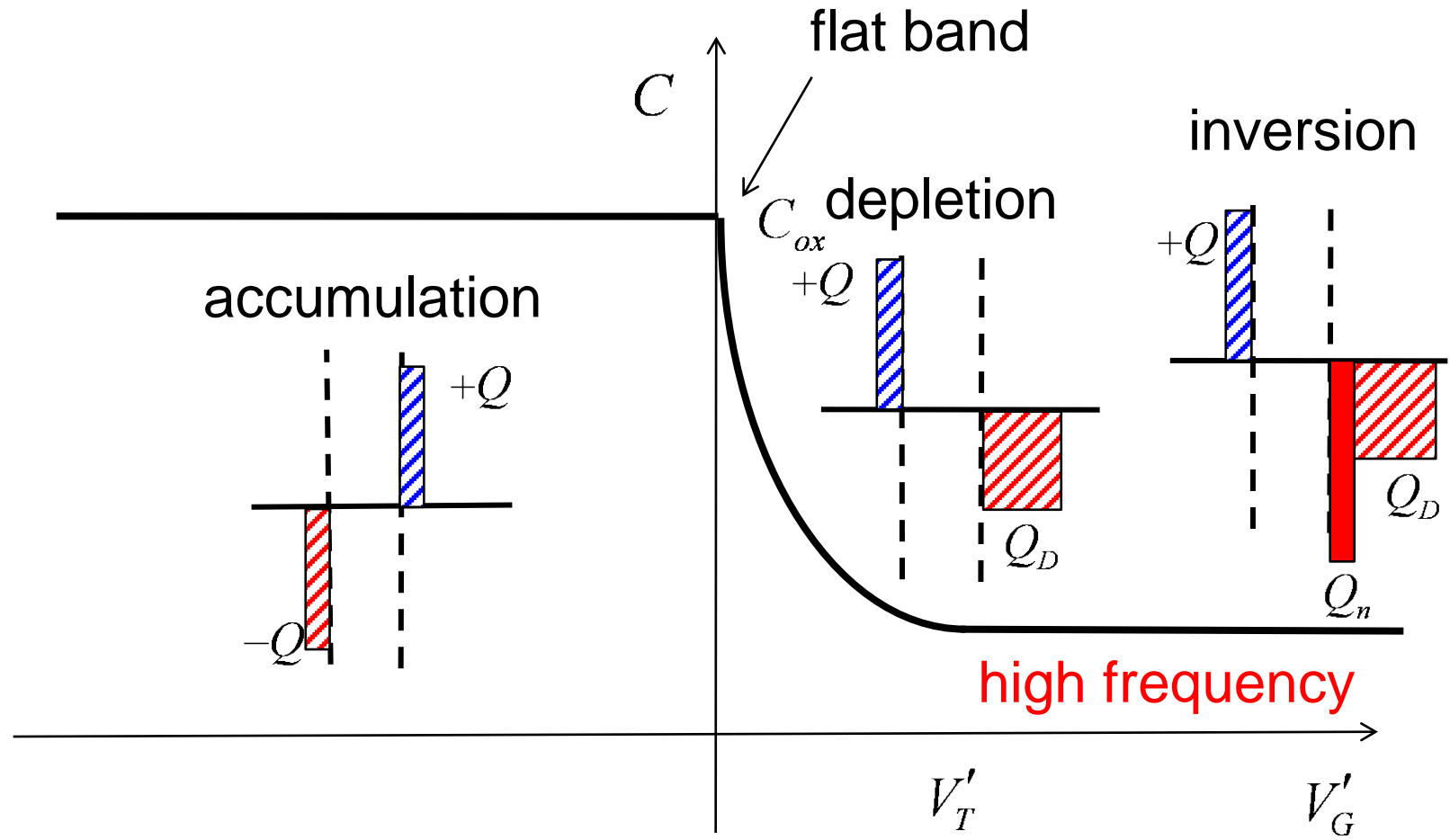
Two capacitors in series



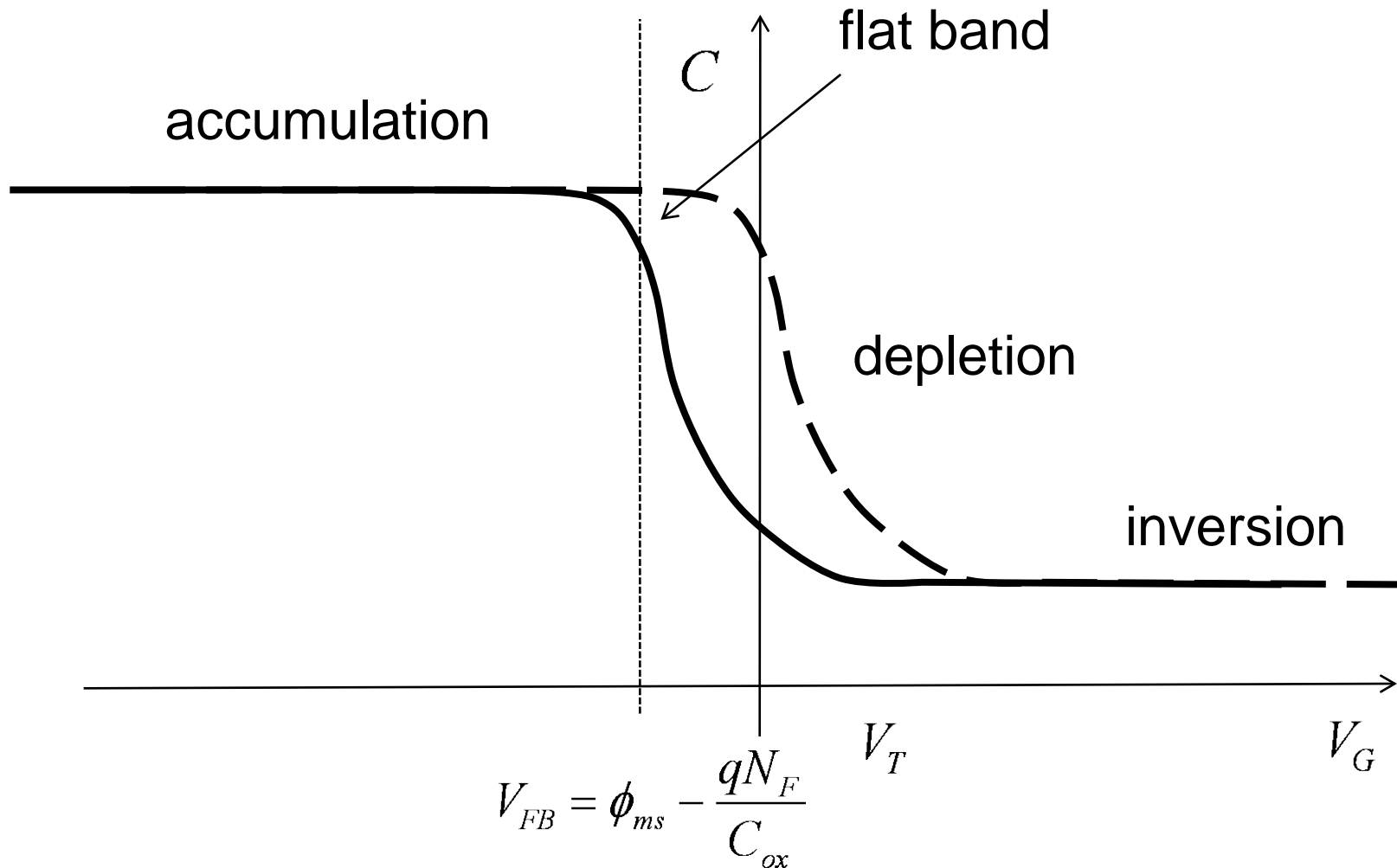
Small signal gate capacitance vs. d.c. gate bias



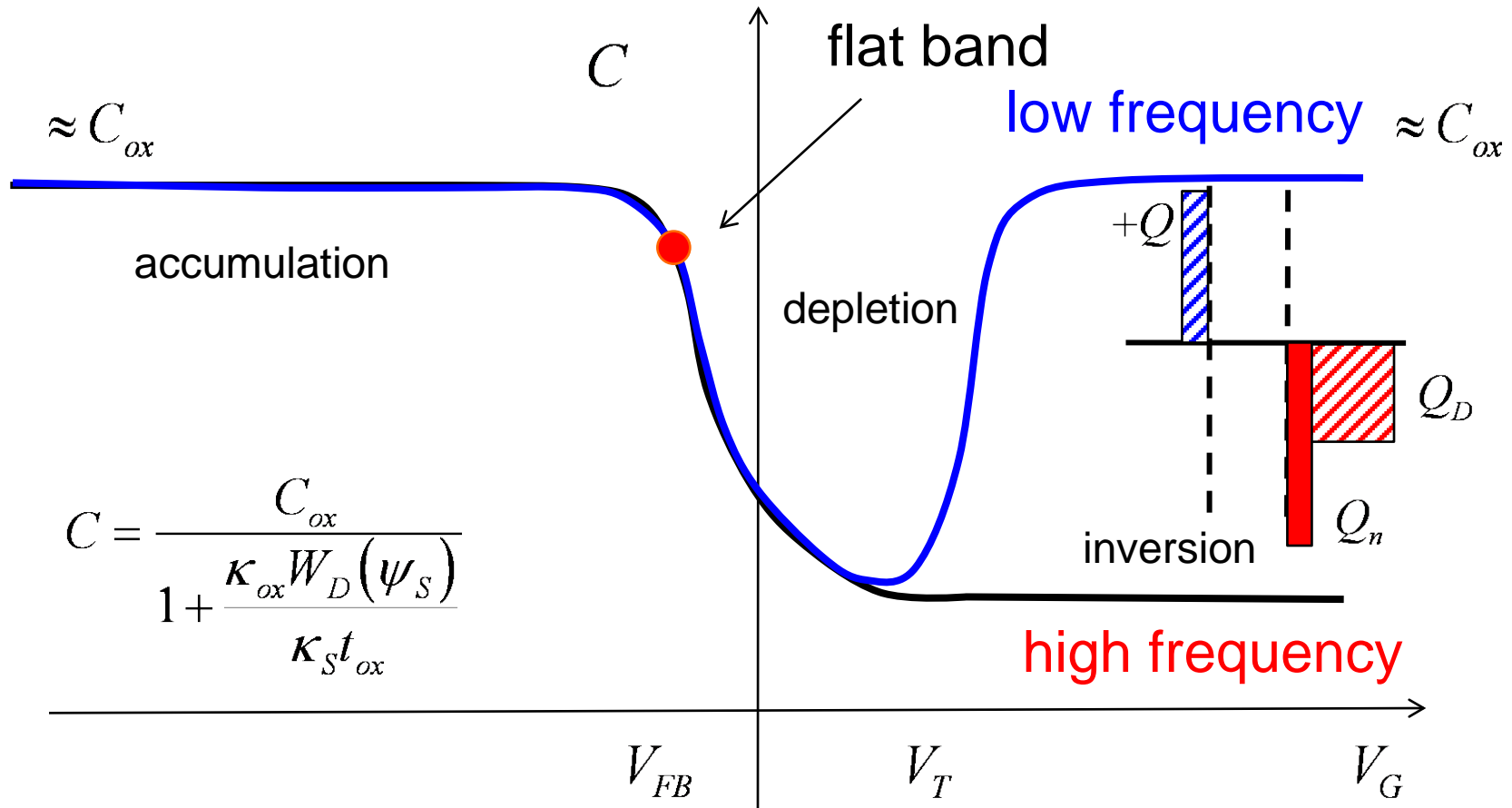
s.s. gate capacitance vs. d.c. gate bias



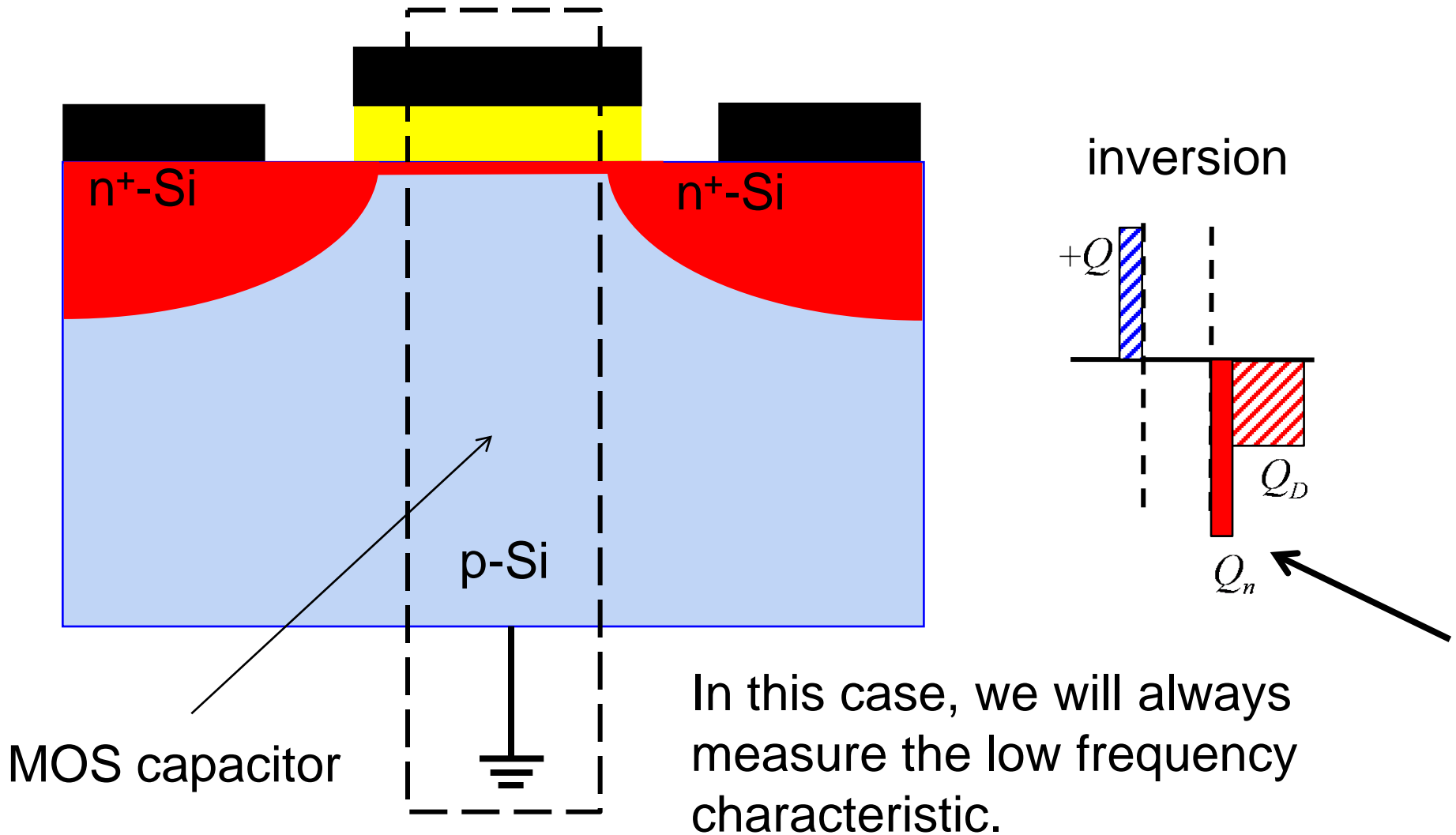
Realistic MOS CV / Critical voltages



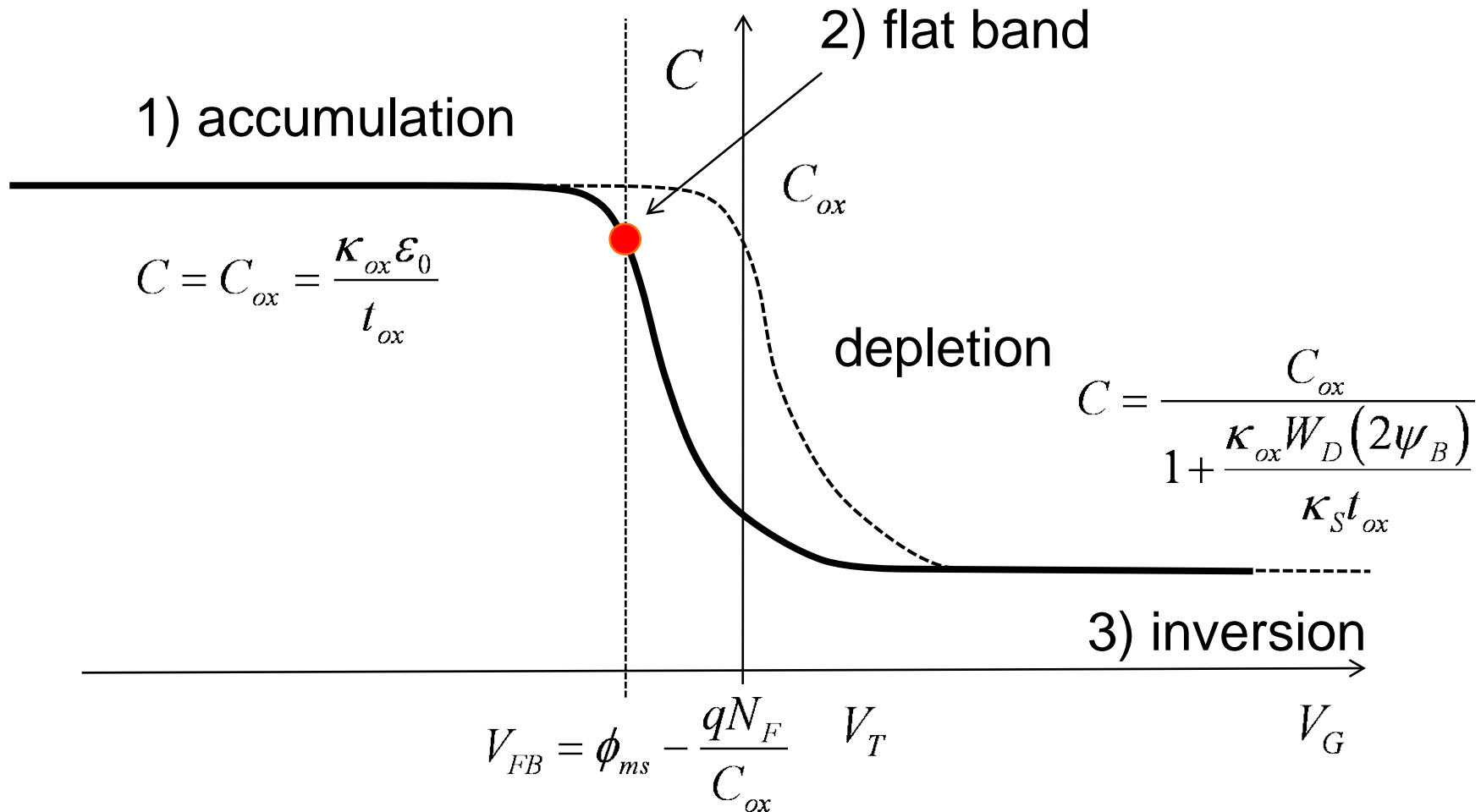
High frequency vs. low frequency CV



HF vs. LF CV



CV measurements as an analysis tool

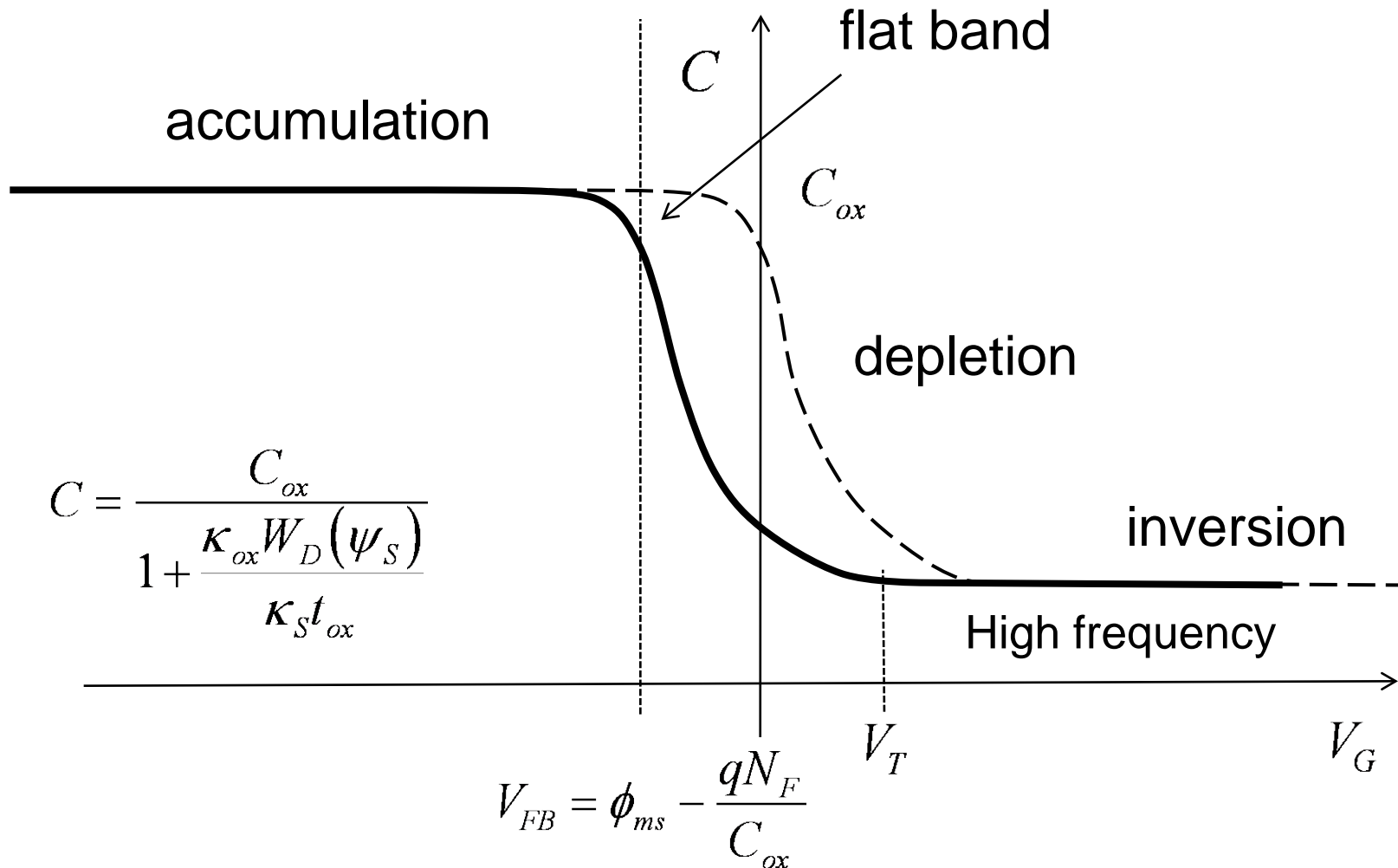


CV measurements as an analysis tool

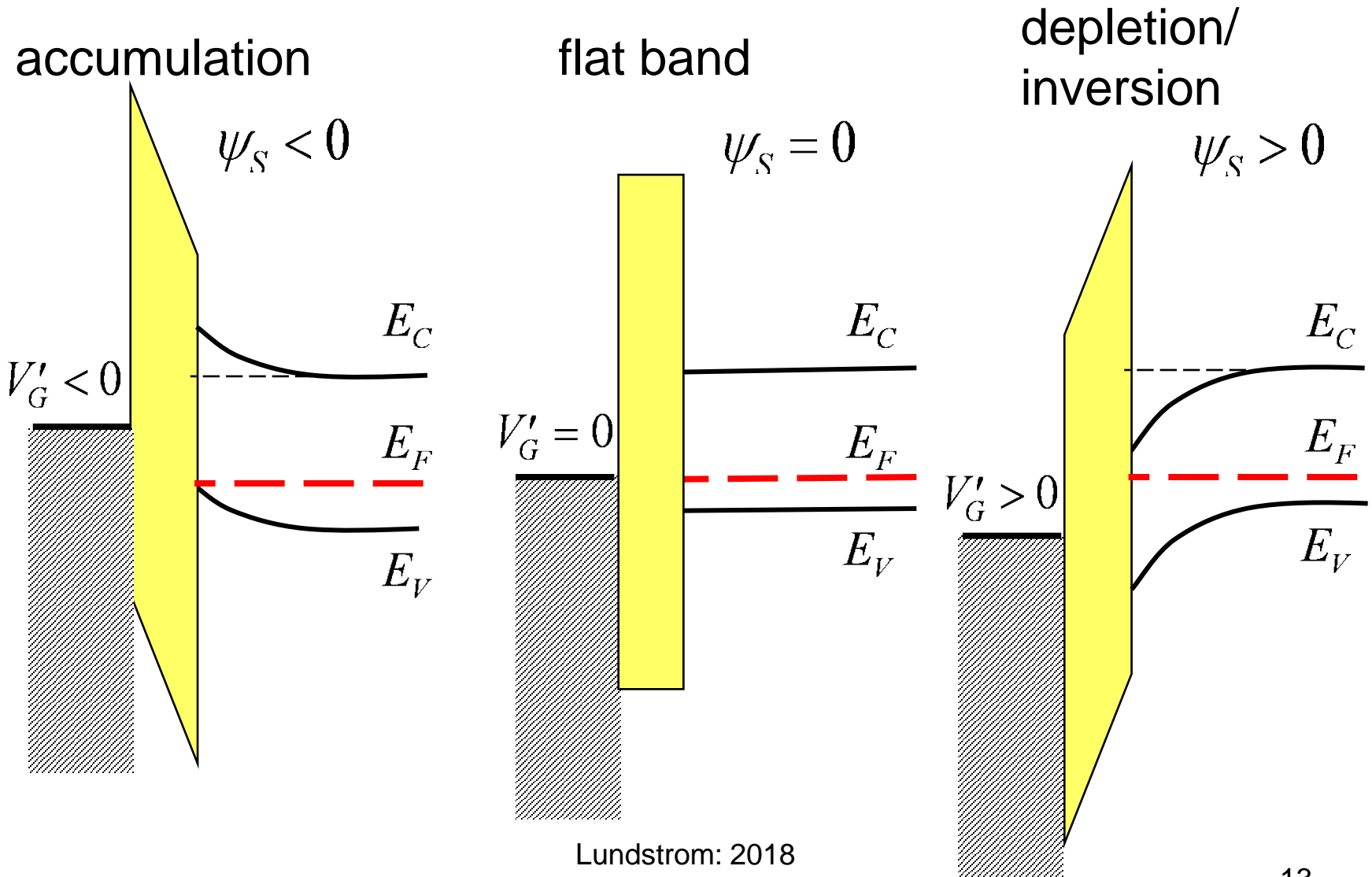
- Oxide thickness
- Flatband voltage
- Doping density

More advanced techniques can also probe various types of charges in the oxide and at the oxide/semiconductor interface.

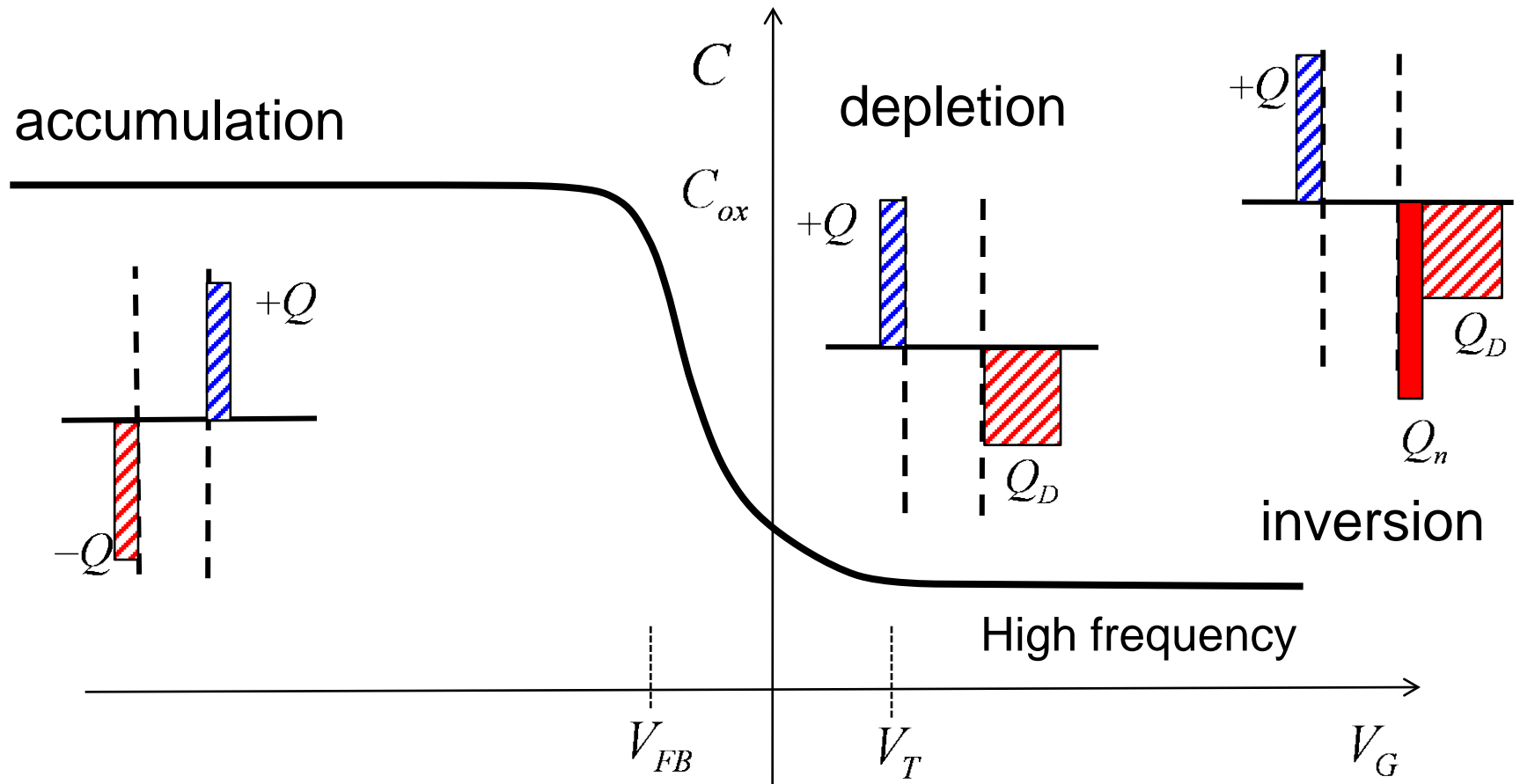
Summary (i)



Summary (ii)



Summary (iii)



Next topic

The mobile charge (the electron or holes in the inversion layer) carries the current in a device.

Our goal in the next lecture is to understand how the mobile charge varies with surface potential and gate voltage.

$$Q_n(\psi_s) \qquad Q_n(V_G)$$